

9-29-03



Attorney Docket No. MTI-31607

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| U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231 | | ATTY. DOCKET NO. MTI-31607 | Serial No. 10/050,507 |
| SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (SEPT. - 2003) | | Applicant Lee, Teck Kheng | Confirmation No. 7687 |
| | | Filing Date January 16, 2002 | Group Art Unit 2813 |

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| Examiner Initials | <i>Craig A. Den</i> | Date Considered | <i>4-4-5</i> |
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Patent

Attorney Docket No. MTI-31607



U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE
Washington, D.C. 20231

**SUPPLEMENTAL
INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
(04-2003)

ATTY. DOCKET NO.

MTI-31607

Serial No.

10/050,507

Applicant

Lee, Teck Kheng

Confirmation No.

7687

Filing Date

01-16-02

Group Art Unit

2813

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| Examiner Initial | | Patent Number | Issue Date | Patentee | U.S. Class | Sub-Class | Filing Date |
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| INFORMATION DISCLOSURE STATEMENT BY APPLICANT | | Applicant Lee, Teck Kheng | Confirmation No. 7687 |
| | | Filing Date 01-16-02 | Group Art Unit 2812 |

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2-8-05

Patent

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U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE
Washington, D.C. 20231

SUPPLEMENTAL
INFORMATION DISCLOSURE
STATEMENT BY APPLICANT
(February 8, 2005)

ATTY. DOCKET NO.

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Serial No.

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Applicant

Lee, Teck Kheng

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7687

Filing Date

January 16, 2002

Group Art Unit

2813

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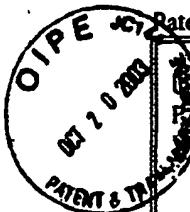
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10-20-03



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| SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT (OCT 2003) | | Applicant Lee, Teck Kheng | Confirmation No. 7687 |
| | | Filing Date January 16, 2002 | Group Art Unit 2813 |

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| U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313 | ATTY. DOCKET NO. MTI-31607 | Serial No. 10/050,507 |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT | Applicant Teck Kheng Lee | Confirmation No. 7687 |
| | Filing Date January 16, 2002 | Group Art Unit 2813 |

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| U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313 | ATTY. DOCKET NO. MTI-31607 | Serial No. 10/050,507 |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT | Applicant Teck Kheng Lee | Confirmation No. 7657 |
| | Filing Date January 16, 2002 | Group Art Unit 2813 |

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Attorney Docket No. MTI-31607

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| <p>U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313</p> <p>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</p> | <p>ATTY. DOCKET NO. MTI-31607</p> <hr/> <p>Applicant Teck Kheng Lee</p> <hr/> <p>Filing Date January 16, 2002</p> | <p>Serial No. 10/030,507</p> <hr/> <p>Confirmation No. 7687</p> <hr/> <p>Group Art Unit 2813</p> |
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1 of 4

SEPT. 20, 2004

Patent

Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE
Alexandria, VA 22313

INFORMATION DISCLOSURE
STATEMENT BY APPLICANT

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| ATTY. DOCKET NO. | Serial No. |
| MTI-31607 | 10/050,507 |
| Applicant | Confirmation No. |
| Teck Kheng Lee | 7687 |
| Filing Date | Group Art Unit |
| January 16, 2002 | 2813 |

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Patent

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| | | Filing Date January 16, 2002 | Group Art Unit 2813 |

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